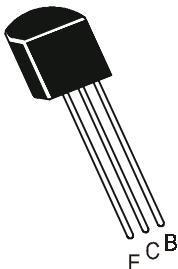


## NPN SILICON EPITAXIAL TRANSISTOR

CSC2120  
TO-92  
BCE



### Audio Power Amplifier Applications.

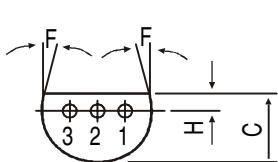
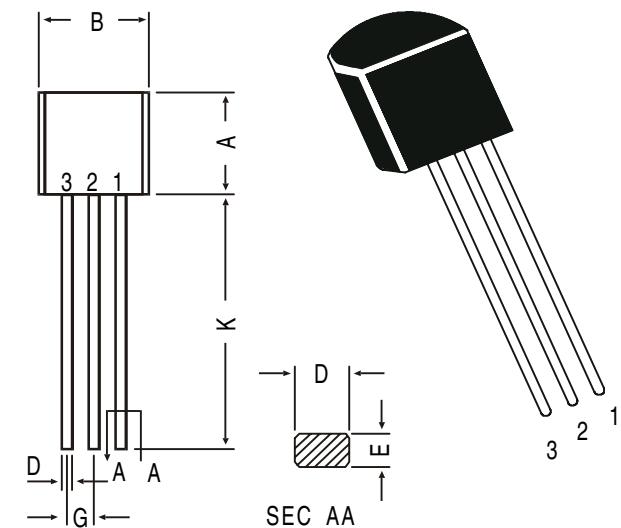
#### ABSOLUTE MAXIMUM RATINGS(Ta=25deg C unless otherwise specified )

DESCRIPTION	SYMBOL	VALUE	UNIT
Collector -Base Voltage	VCBO	35	V
Collector -Emitter Voltage	VCEO	30	V
Emitter Base Voltage	VEBO	5.0	V
Collector Current Continuous	IC	800	mA
Emitter Current	IE	800	mA
Collector Power Dissipation	PC	600	mW
Operating And Storage Junction	T <sub>j</sub> , T <sub>stg</sub>	-55 to +150	deg C
Temperature Range			

#### ELECTRICAL CHARACTERISTICS (Ta=25 deg C Unless Otherwise Specified)

DESCRIPTION	SYMBOL	TEST CONDITION	MIN	TYP	MAX	UNIT
Collector Cut off Current	ICBO	VCB=35V, IE=0	-	-	100	nA
Emitter Cut off Current	IEBO	VEB=5V, IC=0	-	-	100	nA
Collector -Emitter Voltage	VCEO	IC=10mA, IB=0	30	-	-	V
DC Current Gain	hFE*(1)	IC=100mA, VCE=1V	100	-	320	
	hFE*(2)	IC=700mA, VCE=1V	35	-	-	
Collector Emitter Saturation Voltage	VCE(Sat) *	IC=500mA, IB=20mA	-	-	0.5	V
Base Emitter Voltage	VBE(on)	IC=10mA, VCE=1V	0.5	-	0.8	V
<u>Dynamic Characteristics</u>						
Collector Output Capacitance	C <sub>ob</sub>	VCB=10V, IE=0, f=1MHz	-	13	-	pF
Transition Frequency	f <sub>t</sub>	VCE=5V, IC=10mA,	-	120	-	MHz
<u>*(1)hFE CLASSIFICATION</u>		0 : 100 - 200,		Y : 160 - 320,		
<u>*Pulse Test : Pulse Width =300us, Duty Cycle=2%</u>						

## TO-92 Plastic Package

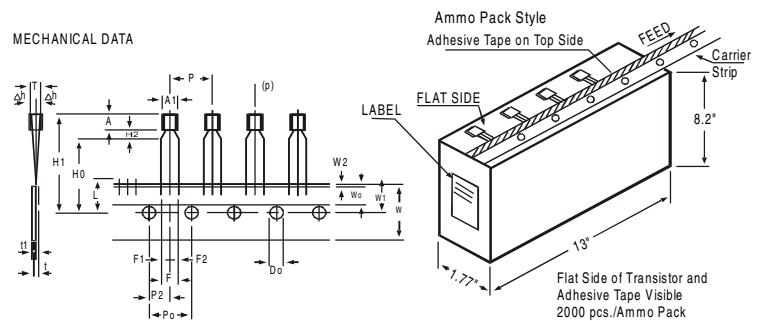


**PIN CONFIGURATION**  
 1. BASE  
 2. COLLECTOR  
 3. Emitter

All dimensions in mm.

DIM	MIN.	MAX.
A	4.32	5.33
B	4.45	5.20
C	3.18	4.19
D	0.41	0.55
E	0.35	0.50
F	5 DEG	
G	1.14	1.40
H	1.14	1.53
K	12.70	—

## TO-92 Transistors on Tape and Ammo Pack



All dimensions in mm unless specified otherwise

ITEM	SYMBOL	SPECIFICATION				REMARKS
		MIN.	NOM.	MAX.	TOL.	
BODY WIDTH	A1	4.0		4.8		
BODY HEIGHT	A	4.8		5.2		
BODY THICKNESS	T	3.9		4.2		
PITCH OF COMPONENT	P					CUMULATIVE PITCH ERROR 1.0 mm/20 PITCH
FEED HOLE PITCH	P0					
FEED HOLE CENTRE TO COMPONENT CENTRE	P2		6.35		±0.4	TO BE MEASURED AT BOTTOM OF CLINCH
DISTANCE BETWEEN OUTER LEADS	F		5.08		+0.6 -0.2	
COMPONENT ALIGNMENT	△h	0		1		AT TOP OF BODY
TAPE WIDTH	W	18				
HOLD-DOWN TAPE WIDTH	Wo	6				
HOLE POSITION	W1	9				
HOLD-DOWN TAPE POSITION	W2		0.5		±0.2	
LEAD WIRE CLINCH HEIGHT	Ho	16		23.25	±0.5	
COMPONENT HEIGHT	H1			11.0		
LENGTH OF SNIPPED LEADS	L					
FEED HOLE DIAMETER	Do	4		1.2	±0.2	t1 0.3 - 0.6
TOTAL TAPE THICKNESS	t					
LEAD - TO - LEAD DISTANCE F1,	F2	2.54			+0.4 -0.1	
CLINCH HEIGHT	H2			3		
PULL - OUT FORCE	(P)	6N				

### NOTES

1. MAXIMUM ALIGNMENT DEVIATION BETWEEN LEADS NOT TO BE GREATER THAN 0.2 mm.
2. MAXIMUM NON-CUMULATIVE VARIATION BETWEEN TAPE FEED HOLES SHALL NOT EXCEED 1 mm IN 20 PITCHES.
3. HOLDDOWN TAPE NOT TO EXCEED BEYOND THE EDGE(S) OF CARRIER TAPE AND THERE SHALL BE NO EXPOSURE OF ADHESIVE.
4. NO MORE THAN 3 CONSECUTIVE MISSING COMPONENTS ARE PERMITTED.
5. A TAPE TRAILER, HAVING AT LEAST THREE FEED HOLES ARE REQUIRED AFTER THE LAST COMPONENT.
6. SPLICES SHALL NOT INTERFERE WITH THE SPROCKET FEED HOLES.

## Packing Detail

PACKAGE	STANDARD PACK		INNER CARTON BOX		OUTER CARTON BOX		
	Details	Net Weight/Qty	Size	Qty	Size	Qty	Gr Wt
TO-92 Bulk	1K/polybag	200 gm/1K pcs	3" x 7.5" x 7.5"	5.0K	17" x 15" x 13.5"	80.0K	23 kgs
TO-92 T&A	2K/ammo box	645 gm/2K pcs	12.5" x 8" x 1.8"	2.0K	17" x 15" x 13.5"	32.0K	12.5 kgs

## Notes

### Disclaimer

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